

**METHOD FOR WAFER-LEVEL MANUFACTURING OF OBJECTS AND
CORRESPONDING SEMI-FINISHED PRODUCTS**

Abstract

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The method for manufacturing an object comprises the steps of

- (a) providing a wafer comprising a multitude of semi-finished objects;
- (b) separating said wafer into parts referred to as sub-wafers, at least one of said sub-wafers comprising a plurality of said semi-finished objects;

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- (c) processing at least a portion of said plurality of semi-finished objects by subjecting said at least one sub-wafer to at least one processing step;

and preferably also the step of

- (d) separating said at least one sub-wafer into a plurality of parts.

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(Fig. 6)